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RF360 Europe GmbH

Data sheet

Date:

Micro-acoustic filter WLAN 2G

Part number: B7530 Ordering code: B39242B7530L210

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1 Application

- Ultra low-loss single filter for Bluetooth/WLAN applications in smartphones with LTE coexistence
- Excellent insertion attenuation
- High out of band selectivity
- Unbalanced to unbalanced operation
- Filter impedance 50 Ω
- Ultra small size 0907 4-pin package

2 Features

- Package size 0.9 mm × 0.7 mm
- Package height 0.56 mm (max.)
- Approximate weight 1 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

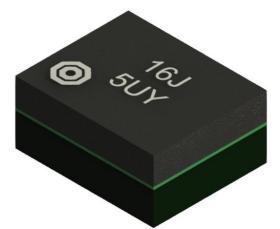
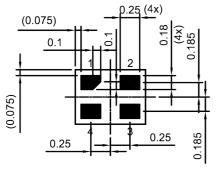


Figure 1: Picture of component with example of product marking.

3 Package

BOTTOM VIEW



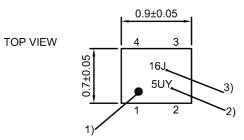
4 Pin configuration

- 1 Input (to PA (unbalanced))
- 3 Output (to ANT (unbalanced))
- 2, 4 Ground

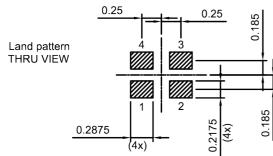
Pad and Pitch Tolerance ±0.05

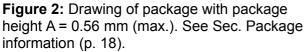
SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number







5 **Matching circuit**

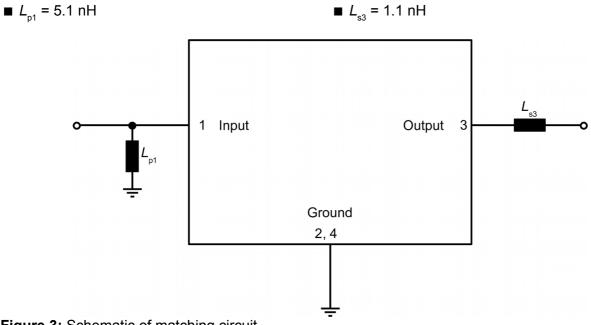


Figure 3: Schematic of matching circuit.

6 **Characteristics**

Temperature range for specification	T _{SPEC}	= −30 °C +85 °C
Input terminating impedance	Z	= 50 Ω // 5.1 nH ¹⁾
Output terminating impedance	Ζ _{ουτ}	= 50 Ω + 1.1 nH ¹⁾

Characteristics			min. for T_{SPEC}	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } \mathcal{T}_{\text{SPEC}} \end{array}$	
Center frequency		f		2442	—	MHz
Insertion loss – WLAN		(x			
Channel 1	2403.1 2420.9	MHz	_	0.8 ²⁾	1.2 ²⁾	dB
Channel 2	2408.1 2425.9	MHz	_	0.72)	1.2 ²⁾	dB
Channel 3-10	2413.1 2465.9	MHz	_	0.6 ²⁾	1.2 ²⁾	dB
Channel 11	2453.1 2470.9	MHz	_	0.72)	1.2 ²⁾	dB
Channel 12	2458.1 2475.9	MHz	_	0.8 ²⁾	1.6 ²⁾	dB
Channel 13	2463.1 2480.9	MHz	_	1.0 ²⁾	1.9 ²⁾	dB
Insertion loss – Bluetooth		(x			
Channel 0-39	2401.5 2440.5	MHz	_	1.2 ³⁾	1.8 ³⁾	dB
Channel 40-78	2440.5 2480.5	MHz	_	1.5 ³⁾	3.3 ³⁾	dB
VSWR						
@ input port	2403.1 2480.9	MHz	_	1.3	1.8 ⁴⁾	
	2403.1 2480.9	MHz	_	1.3	2.2	
@ output port	2403.1 2480.9	MHz	_	1.3	1.8 ⁴⁾	
	2403.1 2480.9	MHz	—	1.3	2.1	
Attenuation		(r			
	100 1805	MHz	36	39	—	dB
	1805 2170	MHz	36	39	-	dB
	2300 2360	MHz	46 ⁶⁾	57 ⁶⁾	_	dB
	2360 2365	MHz	43 ⁶⁾	53 ⁶⁾	-	dB
	2365 2370	MHz	42 ⁶⁾	47 ⁶⁾	_	dB
	2370 2380	MHz	8 ⁶⁾	32 ⁶⁾	_	dB
	2496 2501	MHz	17 ^{5),6)}	37 ⁶⁾	_	dB
	2500 2510	MHz	35 ^{5),6)}	55 ⁶⁾	_	dB
	2510 2540	MHz	45 ⁶⁾	49 ⁶⁾	_	dB
	2540 2570	MHz	42 ⁶⁾	45 ⁶⁾	_	dB
	2570 2690	MHz	36 ⁶⁾	41 ⁶⁾	_	dB
	4800 5000	MHz	45	55	_	dB
	5000 5805	MHz	35	41	—	dB
	7200 7500	MHz	35	45	_	dB

1) See Sec. Matching circuit (p. 6).

2) Averaged values of linear S-parameter over any 17.8 MHz.

3) Averaged value within each Bluetooth channel width of 1 Mhz.

4)

Valid for typical temperature T = +25 °C. Valid for temperature T = +25 °C...+85 °C. 5)

6) Averaged values of linear S-parameter over any 5 MHz.

7 **Maximum ratings**

Storage temperature	$T_{\rm STG}^{2)} = -40 ^{\circ}{\rm C} \dots +85 ^{\circ}{\rm C}^{1)}$	
DC voltage	$ V_{\rm DC} = 5.0 {\rm V}^{6)}$	
ESD voltage		
	$V_{\rm ESD}^{3)}$ = 100 V (max.)	Machine model.
	$V_{\rm ESD}^{4)}$ = 150 V (max.)	Human body model.
	$V_{\rm ESD}^{5)}$ = 600 V (max.)	Charged device model.
Input power @ input port: 2403.1 2480.9 MHz	P _{IN} = 25 dBm	19 MHz WLAN signal for 5000 h @ 55 °C. Duty cycle 64%. Effective power in On- state.

1)

Extended upper limit: 96h@125°C acc. to IEC60068-2-2 Bb. Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C. 2)

3) According to JESD22-A115B (MM - Machine Model), 10 negative & 10 positive pulses.

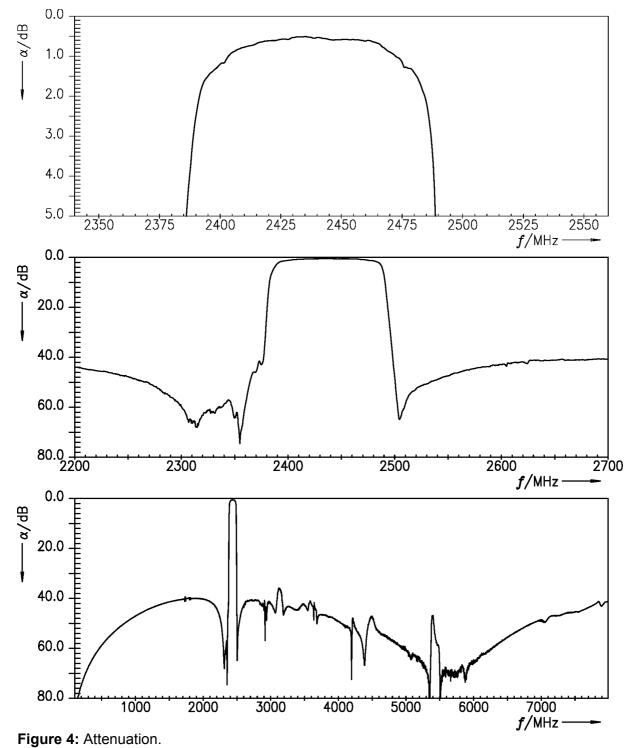
4)

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse. According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses. 5)

6) 168h Damp Heat Steady State acc. to IEC60068-2-67 Cy.



8 Transmission coefficient





9 Reflection coefficients

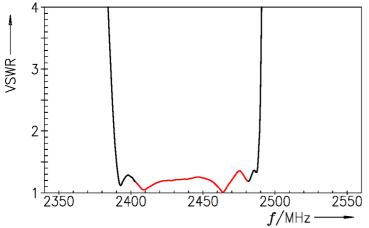


Figure 5: Reflection coefficient at input port.

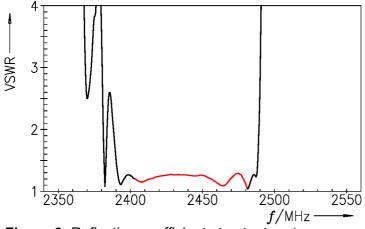
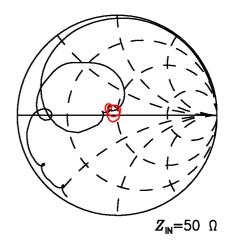
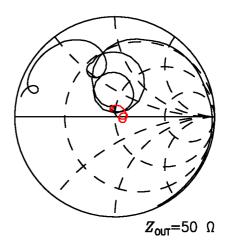


Figure 6: Reflection coefficient at output port.

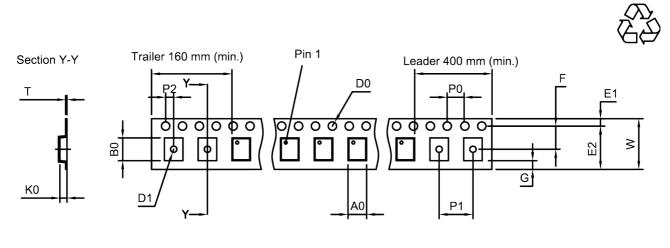






10 Packing material

10.1 Tape



User direction of unreeling

Figure 7: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 $\begin{array}{c|c} A_0 & 0.82_{\pm 0.05} \text{ mm} \\ \hline B_0 & 1.02_{\pm 0.05} \text{ mm} \\ \hline D_0 & 1.5_{\pm 0.1/-0} \text{ mm} \\ \hline D_1 & 0.4_{\pm 0.05} \text{ mm} \\ \hline E_1 & 1.75_{\pm 0.1} \text{ mm} \end{array}$

Table 1: Tape dimensions.

E2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K ₀	0.61±0.03 mm
P ₀	4.0±0.1 mm

P ₁	2.0±0.05 mm
P ₂	2.0±0.05 mm
Т	0.2±0.02 mm
W	8.0+0.3/-0.1 mm



10.2 Reel with diameter of 180 mm

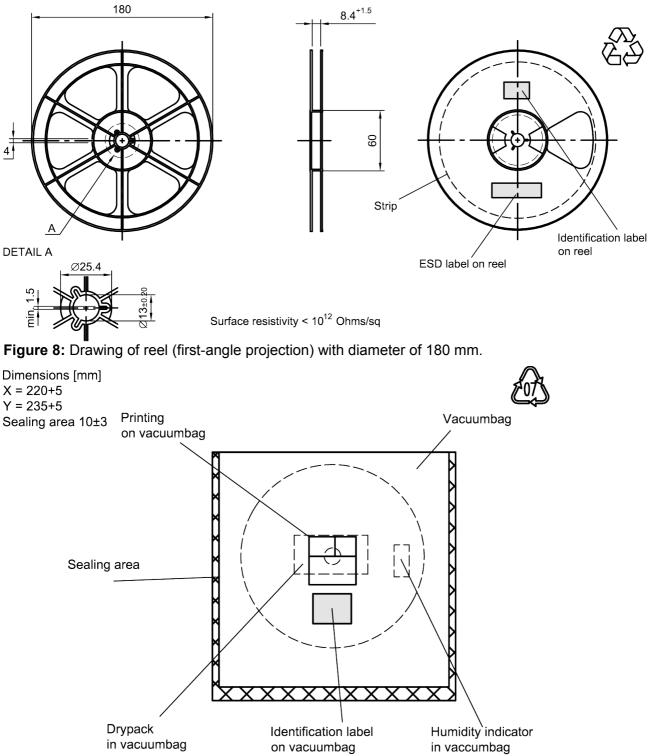


Figure 9: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

Please read **Cautions and warnings** and **Important notes** at the end of this document.

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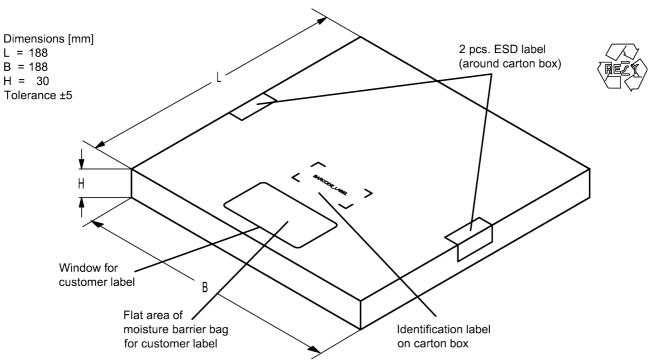
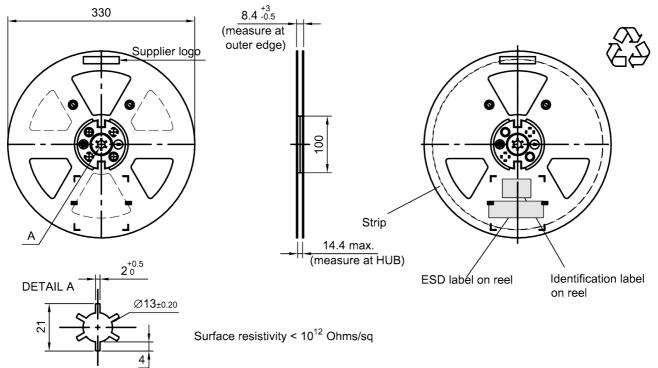
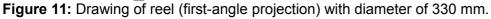


Figure 10: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm







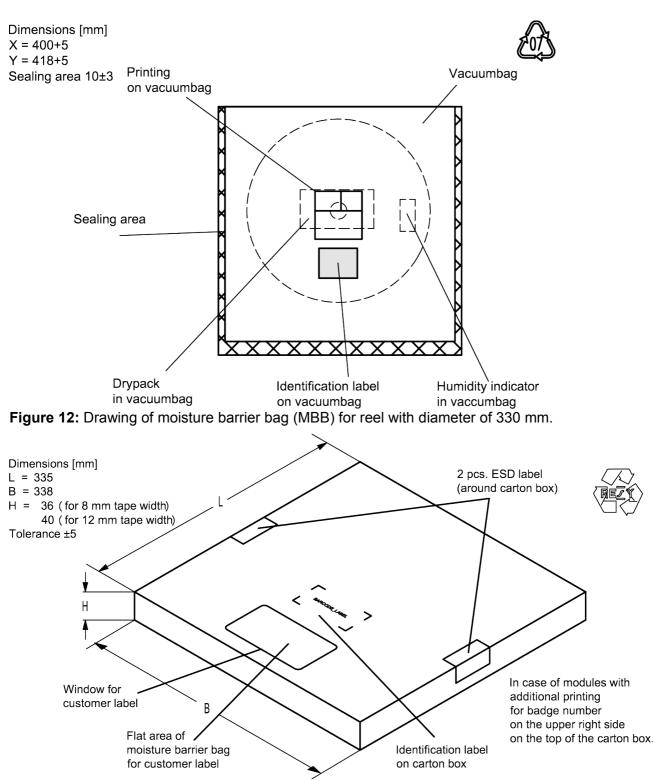


Figure 13: Drawing of folding box for reel with diameter of 330 mm.

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11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit r	narking.	e.g., B3xxxxB <u>1234</u> xxxx,
Example of decoding type number marking on or 16J	device	in decimal code.
1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0	=>	1234
The BASE32 code for product type B7530 is 7BA.	=	1234

■ Lot number:

The last 5 digits of the lot number, 12345, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device **5UY**

decoding lot number marking on device		in decimal code.
5UY	=>	12345
5 x 47 ² + 27 (=U) x 47 ¹ + 31 (=Y) x 47 ⁰	=	12345

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	М
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	А	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	K	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T _{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

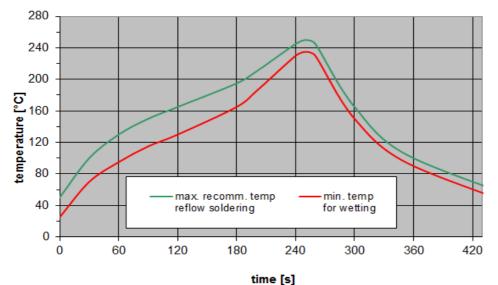


Figure 14: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.3 Ordering codes and packing units

Ordering code	Packing unit
B39242B7530L210	15000 pcs
B39242B7530L210S 5	5000 pcs

Table 4: Ordering codes and packing units.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



15 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (<u>https://rffe.qualcomm.com</u>). Should you have any more detailed questions, please contact our sales offices.
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